TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSVII)

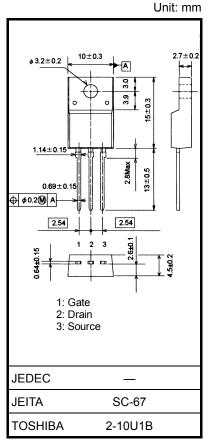
TK10A60D

Switching Regulator Applications

- Low drain-source ON-resistance: $R_{DS\ (ON)}$ = 0.62 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 6.0 S (typ.)
- Low leakage current: $I_{DSS} = 10 \mu A (V_{DS} = 600 V)$
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	600	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	600	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	ΙD	10		
	Pulse (t = 1 ms) (Note 1)	I _{DP}	40	Α	
Drain power dissipation (Tc = 25°C)		P _D	45	W	
Single pulse avalanche energy (Note 2)		E _{AS}	363	mJ	
Avalanche current		I _{AR}	10	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	4.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

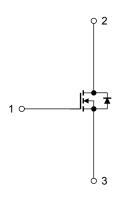
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 6.36 mH, $R_G = 25 \Omega$, $I_{AR} = 10 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



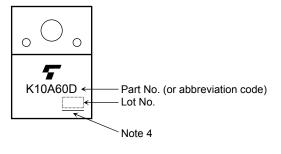
Electrical Characteristics (Ta = 25°C)

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μА
Drain cut-off current		I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V			10	μА
Drain-source bre	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	600			٧
Gate threshold v	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0		4.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 5 A		0.62	0.75	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 5 A	1.5	6.0		S
Input capacitance		C _{iss}		_	1350	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		6		pF
Output capacitance		C _{oss}			135		
Switching time	Rise time	t _r	$\begin{array}{c c} 10 \text{ V} & \text{ID} = 5 \text{ A} & \text{Vout} \\ \hline VGS & \\ 0 \text{ V} & \\ \hline SO \Omega & \\ \end{array} \begin{array}{c} R_L = \\ 40 \Omega \\ \end{array}$ $\text{VDD} \simeq 200 \text{ V}$	_	22	_	- ns
	Turn-on time	t _{on}		_	55	_	
	Fall time	t _f			15		
	Turn-off time	t _{off}	Duty \leq 1%, $t_W = 10 \mu s$	_	100	_	
Total gate charge		Qg		_	25	_	
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	_	16	_	nC
Gate-drain charge		Q _{gd}]	_	9	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	_	_	_	10	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	40	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.7	٧
Reverse recovery time	t _{rr}	$I_{DR} = 10 \text{ A}, V_{GS} = 0 \text{ V},$		1300		ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 100 A/μs	_	12	_	μС

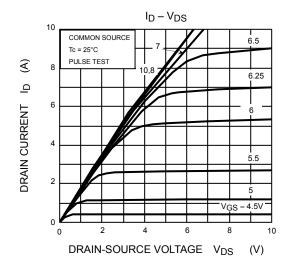
Marking

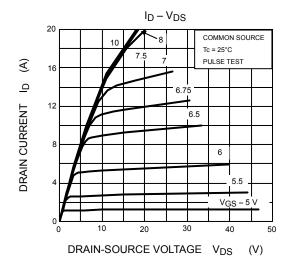


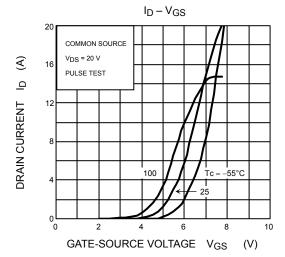
Note 4: A line under a Lot No. identifies the indication of product Labels.

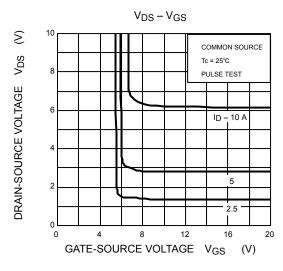
[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

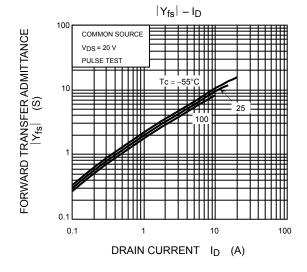
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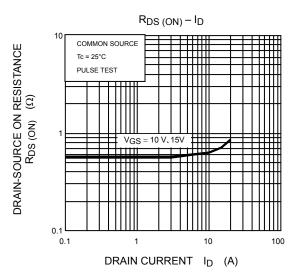


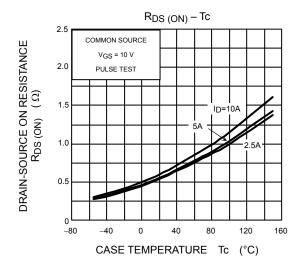


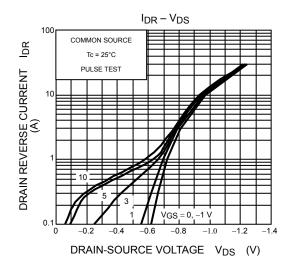


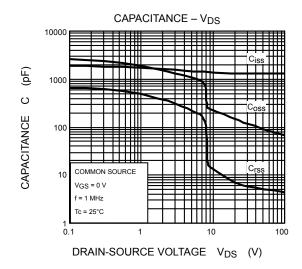


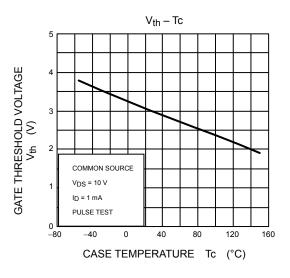


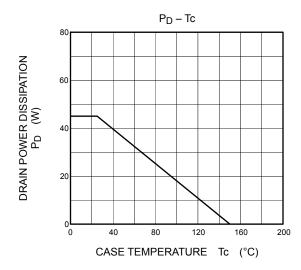


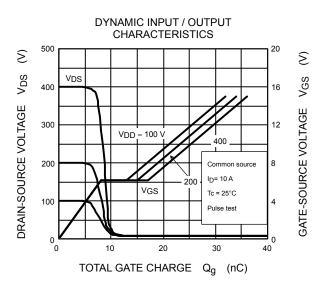


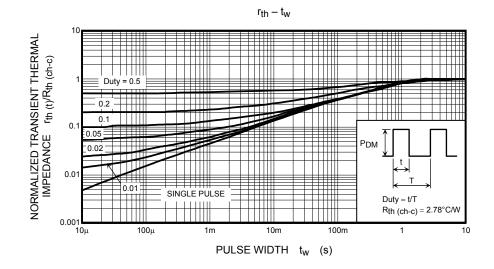


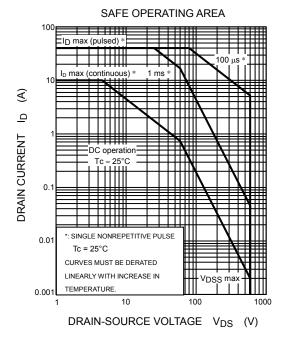


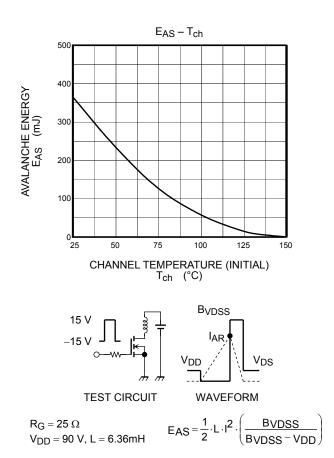












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